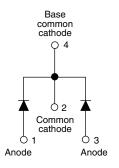


HALOGEN

FREE

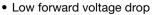
Schottky Rectifier, 2 x 6 A

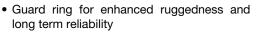




PRODUCT SUMMARY				
Package	D-PAK (TO-252AA)			
I _{F(AV)}	2 x 6 A			
V_{R}	60 V			
V _F at I _F	0.57 V			
I _{RM}	35 mA at 125 °C			
T _J max.	150 °C			
Diode variation	Common cathode			
E _{AS}	7 mJ			

FEATURES





- Popular D-PAK outline
- Center tap configuration
- Small foot print, surface mountable
- High frequency operation
- AEC-Q101 qualified
- Meets JESD 201 class 2 whisker test
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



The VS-12CWQ06FNHM3 surface mount, center tap, Schottky rectifier series has been designed for applications requiring low forward drop and small foot prints on PC board. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL CHARACTERISTICS VALUES UNITS						
I _{F(AV)}	Rectangular waveform	12	А			
V_{RRM}		60	V			
I _{FSM}	t _p = 5 μs sine	320	А			
V _F	6 A _{pk} , T _J = 125 °C (per leg)	0.57	V			
T _J	Range	- 55 to 150	°C			

VOLTAGE RATINGS						
PARAMETER SYMBOL VS-12CWQ06FNHM3 UNITS						
Maximum DC reverse voltage	V_{R}	60	V			
Maximum working peak reverse voltage	V_{RWM}	00	V			

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDI	TIONS	VALUES	UNITS	
Maximum average per le	~ I .	50 % duty cycle at T _C = 131 °C, rectangular waveform		6	А	
See fig. 5 per device	e I _{F(AV)}			12		
Maximum peak one cycle		5 μs sine or 3 μs rect. pulse	Following any rated	320	Α	
non-repetitive surge current See fig. 7	IFSM	10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	105	A	
Non-repetitive avalanche energy per leg	E _{AS}	T _J = 25 °C, I _{AS} = 1.2 A, L = 10 mH		7	mJ	
Repetitive avalanche current per leg	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T_J maximum $V_A = 1.5 \times V_R$ typical		0.8	Α	



ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS		
		6 A	T _{.1} = 25 °C	0.61	V	
Maximum forward voltage drop per leg	V (1)	12 A	1j=25 C	0.79		
See fig. 1	V _{FM} ⁽¹⁾	6 A	T _{.1} = 125 °C	0.57		
3		12 A	1j = 125 C	0.72		
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	V _B = Rated V _B	3	m A	
See fig. 2	'RM ` ′	T _J = 125 °C	VR = nateu VR	35	- mA	
Threshold voltage	V _{F(TO)}	T T		0.36	V	
Forward slope resistance	r _t	$T_J = T_J$ maximum	24.14	mΩ		
Typical junction capacitance per leg	C _T	$V_R = 5 V_{DC}$, (test signal ran	360	pF		
Typical series inductance per leg	L _S	Measured lead to lead 5 m	nm from package body	5.0	nH	

Note

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range		T _J ⁽¹⁾ , T _{Stg}		- 55 to 150	°C
Maximum thermal resistance,	per leg	D	DC operation	3.0	°C/W
junction to case	per device	R _{thJC}	See fig. 4	1.5	C/ VV
Approximate weight				0.3	g
Approximate weight				0.01	OZ.
Marking device			Case style D-PAK	12CWC	06FNH

Note

$$^{(1)} \quad \frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}} \quad \text{thermal runaway condition for a diode on its own heatsink}$$



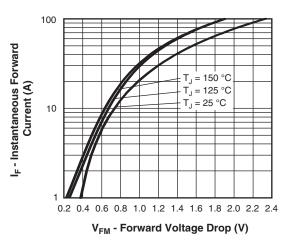


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

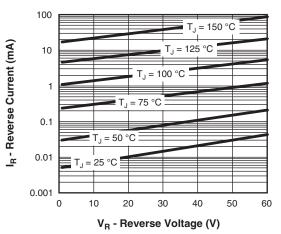


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

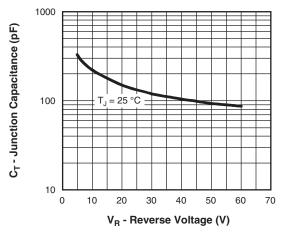


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

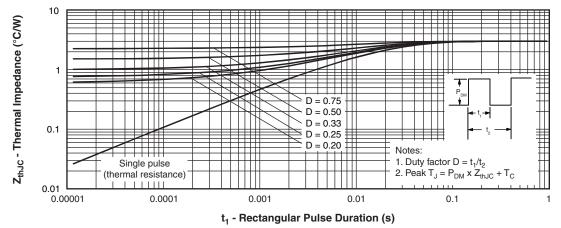
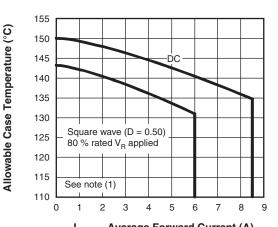


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)



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I_{F(AV)} - Average Forward Current (A)

Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

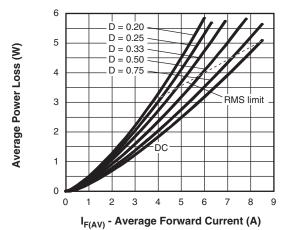


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

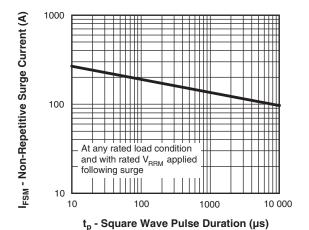


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

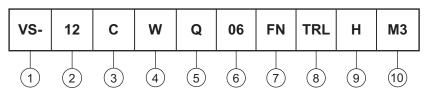
Note

 $^{(1)}$ Formula used: $T_{C} = T_{J}$ - (Pd + Pd_{REV}) x R_{thJC}; Pd = Forward power loss = $I_{F(AV)}$ x V_{FM} at ($I_{F(AV)}/D$) (see fig. 6); Pd_{REV} = Inverse power loss = V_{R1} x I_R (1 - D); I_R at V_{R1} = 80 % rated V_R



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (12 A)

Center tap configuration

Package identifier:

W = D-PAK

5 - Schottky "Q" series

- Voltage rating (06 = 60 V)

7 - FN = TO-252AA

8 - • None = Tube

• TR = Tape and reel

• TRL = Tape and reel (left oriented)

• TRR = Tape and reel (right oriented)

9 - H = AEC-Q101 qualified

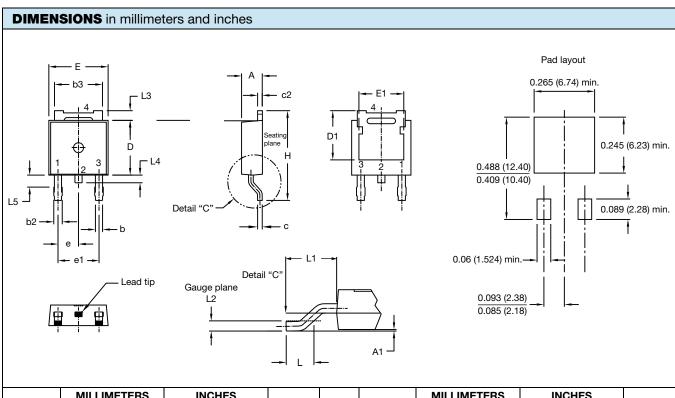
10 - Environmental digit:

M3 = Halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION		
VS-12CWQ06FNHM3	75	3000	Antistatic plastic tube		
VS-12CWQ06FNTRHM3	2000	2000	13" diameter reel		
VS-12CWQ06FNTRRHM3	3000	3000	13" diameter reel		
VS-12CWQ06FNTRLHM3	3000	3000	13" diameter reel		

LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95519</u>				
Part marking information	www.vishay.com/doc?95518			
Packaging information	www.vishay.com/doc?95033			

DPAK (TO-252AA)



SYMBOL MILLIMETERS INCHE		HES	NOTES		
STINIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	2.18	2.39	0.086	0.094	
A1	ı	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	5.21	-	0.205	-	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

MILLIM	IETERS	INCHES		NOTES
MIN.	MAX.	MIN.	MAX.	NOTES
2.29	BSC	0.090	BSC	
9.40	10.41	0.370	0.410	
1.40	1.78	0.055	0.070	
2.74	BSC	0.108	REF.	
0.51	BSC	0.020	BSC	
0.89	1.27	0.035	0.050	3
ı	1.02	-	0.040	
1.14	1.52	0.045	0.060	2
	9.40 1.40 2.74 0.51 0.89	2.29 BSC 9.40	MIN. MAX. MIN. 2.29 BSC 0.090 9.40 10.41 0.370 1.40 1.78 0.055 2.74 BSC 0.108 0.51 BSC 0.020 0.89 1.27 0.035 - 1.02 -	MIN. MAX. MIN. MAX. 2.29 BSC 0.090 BSC 9.40 10.41 0.370 0.410 1.40 1.78 0.055 0.070 2.74 BSC 0.108 REF. 0.51 BSC 0.020 BSC 0.89 1.27 0.035 0.050 - 1.02 - 0.040

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Dimensions D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (5) Outline conforms to JEDEC® outline TO-252AA



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